



## UNITED STATES PATENT AND TRADEMARK OFFICE

DATE MAILED: 06/04/2003

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
09/612,298 07/07/2000		Tatsuya Kunikiyo	193414US2	8554	
22850	7590 06/04/2003				
•	PIVAK, MCCLELLAI	EXAMINER			
1940 DUKE ALEXANDR	STREET SIA, VA 22314	CAO, PHAT X			
			ART UNIT	PAPER NUMBER	
		2814			

Please find below and/or attached an Office communication concerning this application or proceeding.

<del>, -</del>				T A	-			p/	
•		•		Application	i No.	Applicant(s)			
	Offic	Action Com		09/612,298		KUNIKIYO, TATSI	JYA		
	Onic	Action Sum	mary	Examiner		Art Unit			
			······································	Phat X. Cad		2814			
Period fo		LING DATE of this	communication app	ears on the (	cover sheet with the c	orrespondence ad	dress		
THE - Exte afte - If th - If NO - Fails - Any	MAILING E ensions of time r r SIX (6) MONTI e period for repl D period for repl ure to reply within reply received b	DATE OF THIS C may be available under the from the mailing dates y specified above is less y is specified above, the in the set or extended pe	OMMUNICATION. ne provisions of 37 CFR 1.13 of this communication. than thirty (30) days, a reply maximum statutory period w priod for reply will, by statute, ree months after the mailing	36(a). In no even y within the statute vill apply and will , cause the applic	t, however, may a reply be timely minimum of thirty (30) day expire SIX (6) MONTHS from ation to become ABANDONE nunication, even if timely filed	nely filed s will be considered timely the mailing date of this co			
1) 🖾	Respons	ive to communica	ation(s) filed on 13 N	March 2003					
2a)⊠	•	on is <b>FINAL</b> .		is action is n	on-final				
3)	Since this	s application is in	condition for allowa	ance except	for formal matters, pr ayle, 1935 C.D. 11, 4		e merits is		
Disposit	ion of Clai	ms							
4)🖂	Claim(s)	<u>1,7-15 and 21-23</u>	is/are pending in the	e application	1.				
	4a) Of the	above claim(s) _	is/are withdraw	vn from cons	sideration.				
5)⊠	Claim(s) 1	<i>0-12 and 21-23</i> i	s/are allowed.						
6)⊠	Claim(s) <u>1,7,9 and 13-15</u> is/are rejected.								
7)🖂	Claim(s) 8	is/are objected t	0.						
	Claim(s) _ ion Papers	•	to restriction and/or	r election red	juirement.				
	-		to by the Examiner	г.					
·		_	•		bjected to by the Exar	miner.			
<i>,</i> —				-	e held in abeyance. So				
11)			ction filed on		oroved b)⊡ disappro		er.		
	If approve	ed, corrected drawing	ngs are required in rep			•			
12)	The oath o	r declaration is ob	jected to by the Exa	aminer.					
Priority (	under 35 U	.S.C. §§ 119 and	120						
13)⊠	Acknowled	dgment is made o	of a claim for foreign	priority und	er 35 U.S.C. § 119(a	)-(d) or (f).			
		] Some * c)	_	,	· · ·	, , , , ,			
,		•—	e priority documents	s have been	received.				
		•	•		received in Application	on No.			
* 5	3. Cop	ies of the certified	d copies of the prior the International Bur	ity documen reau (PCT R	ts have been receive	d in this National	Stage		
					er 35 U.S.C. § 119(e		application	٦)	
а	ı) 🔲 The tr	anslation of the fo	oreign language prov	visional appl	ication has been rec	eived.	аррисаноп	1).	
/ لـــا(כו Attachmen		Jinentis made of	a ciaiiii iui uuiiiesti	c priority und	ler 35 U.S.C. §§ 120	anu/or 121.			
1)  Notic	ce of Reference		ı Review (PTO-948) 'O-1449) Paper No(s)	5	) Interview Summary ) Notice of Informal F ) Other:	(PTO-413) Paper No( Patent Application (PTC			

Application/Control Number: 09/612,298 Page 2

Art Unit: 2814

## **DETAILED ACTION**

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1, 7, 9, and 13-15 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP. 10-199882 in view of Lee (US. 5,441,915).

With respect to claims 1, 7 and 9, JP ('882), in Fig. 1 and abstract, discloses a semiconductor device comprising: a semiconductor substrate 1 having a main surface along which a semiconductor element is formed; interlayer insulating films formed on the main surface; conductive interconnections 3, 5, 7, and 9 provided in a plurality of layers separated by the interlayer insulating films; conductive dummy interconnections 3A, 5A, 7A, and 9A provided in the plurality of layers so that every one of the conductive dummy interconnection is formed in a layer of the plurality of layers with at least one conductive interconnection, wherein the dummy interconnections are provided to sandwich an interconnection part included in the interconnections in at least one of the two or more layers; and a conductive dummy plug 4b, 6b, and 8b selectively buried in the interlayer insulating films to connect the dummy interconnections all together.

Application/Control Number: 09/612,298

Art Unit: 2814

JP ('882) does not disclose the dummy interconnections connected to a potential power supply line.

However, Lee, in column 5, lines 57-65, teaches the obviousness of having the dummy lines left floating or grounded depending on their locations. Accordingly, it would have been obvious to connect the dummy lines of JP ('882) to the ground line because according to Lee, the dummy lines would be grounded when the dummy lines are adjacent to signal lines (see column 5, lines 62-65) for the known purpose of preventing cross-talk.

With respect to claims 13-14, JP ('882) also discloses in Fig. 3 the forming of a passivation film 11 covering the uppermost layer and having a higher thermal conductivity than the interlayer insulating films, and the forming of a heat sink 12 which is in contact with the passivation film 11.

With respect to claim 15, in view of teachings of Fig. 2 of JP ('882), it would have been obvious to modify Fig. 3 of JP ('882) by forming another conductive dummy plug (see dummy plugs 10b in Fig. 2) buried in the passivation film to connect the heat sink 12 and part of the dummy interconnection for the purpose of performing heat dissipation more efficiently (see abstract).

3. Claims 1, 7, 9, and 13-15 are rejected under 35 U.S.C. 103(a) as being unpatentable over JP. 10-199882 in view of Ma (US. 5,729,047).

Application/Control Number: 09/612,298 Page 4

Art Unit: 2814

As discussed in details above, JP ('882) substantially reads on the invention as claimed, except it does not disclose the dummy interconnections connected to a potential power supply line.

However, Ma, in Fig. 3, teaches the obviousness of forming the dummy interconnections surrounding the signal interconnection line 90 and connecting to the potential power supply line Vss. Accordingly, it would have been obvious to connect the dummy interconnections of JP ('882) to the power supply line Vss because according to Ma, such modification would provide a signal isolation and decoupling in an integrated circuit device (column 1, lines 55-60).

## Allowable Subject Matter

- 4. Claims 10-12 and 21-23 are allowed.
- 5. Claim 8 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

The prior art fails to disclose the combination of the structure having every one of the conductive dummy interconnection being formed in a layer of the plurality of layers with at least one conductive interconnection, and the dummy interconnection which is provided in a layer located over the at least one layer to <u>cover</u> the interconnection part.

Application/Control Number: 09/612,298 Page 5

Art Unit: 2814

Response to Arguments

6. Applicant argues that Fig. 2 of JP. 882 does not suggest the invention as amended

because the layer in which the conductive dummy interconnection 12 is formed does not have at

least one conductive interconnection.

The Examiner agrees that Fig. 2 does not suggest the above feature. However, Fig. 1 of

JP '882 does suggest the invention as amended (see new ground of rejection for more details).

Conclusion

7. Applicant's amendment necessitated the new ground(s) of rejection presented in this

Office action. Accordingly, THIS ACTION IS MADE FINAL. See MPEP § 706.07(a).

Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE

MONTHS from the mailing date of this action. In the event a first reply is filed within TWO

MONTHS of the mailing date of this final action and the advisory action is not mailed until after

the end of the THREE-MONTH shortened statutory period, then the shortened statutory period

will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR

1.136(a) will be calculated from the mailing date of the advisory action. In no event, however,

will the statutory period for reply expire later than SIX MONTHS from the date of this final

action.

Application/Control Number: 09/612,298

Art Unit: 2814

8. Any inquiry concerning this communication or earlier communications from the examiner

should be directed to Phat X. Cao whose telephone number is (703) 308-4917. The Examiner

can normally be reached on Monday through Thursday. If attempts to reach the Examiner by

telephone are unsuccessfully, the Examiner's supervisor, Wael Fahmy, can be reached on

(703) 308-4918.

Any inquiry of a general nature or relating to the status of this application should be

directed to the Group receptionist whose telephone number is (703) 308-0956. Group 2800 fax

number is (703) 308-7722 or (703) 308-7724.

PC

May 30, 2003

PHAT X. CAO

WIRAARY EXAMINER

Page 6